

Surface Mount Superfast Recovery Rectifier
Reverse Voltage – 50 to 600 V
Forward Current – 3 A
FEATURES

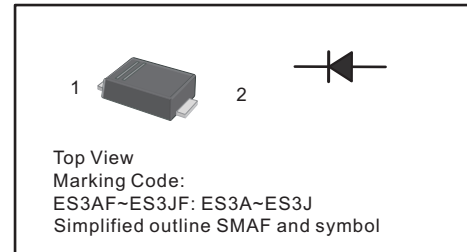
- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Superfast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 27mg 0.00086oz

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode

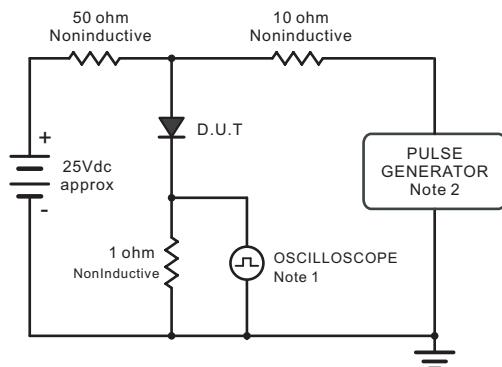

Absolute Maximum Ratings and Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Parameter	Symbols	ES3AF	ES3BF	ES3CF	ES3DF	ES3EF	ES3GF	ES3JF	Units
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	V _{DC}	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current at T _L = 100 °C	I _{F(AV)}	3							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	100							A
Maximum Forward Voltage at 3A	V _F	1				1.25		1.7	V
Maximum DC Reverse Current at Rated DC Blocking Voltage Ta = 25 °C Ta =125 °C	I _R	5 200							μA
Typical Junction Capacitance at V _R =4V, f=1MHz	C _j	45							pF
Maximum Reverse Recovery Time at I _F =0.5A, I _R =1A, I _{rr} =0.25A	t _{rr}	35							ns
Operating and Storage Temperature Range	T _j , T _{stg}	-55 ~ +150							°C



Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram



Note: 1. Rise Time = 7ns, max.
Input Impedance = 1megohm, 22pF.
2. Rise Time = 10ns, max.
Source Impedance = 50 ohms.

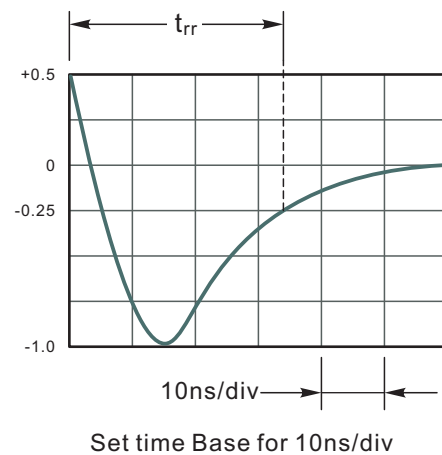


Fig.2 Maximum Average Forward Current Rating

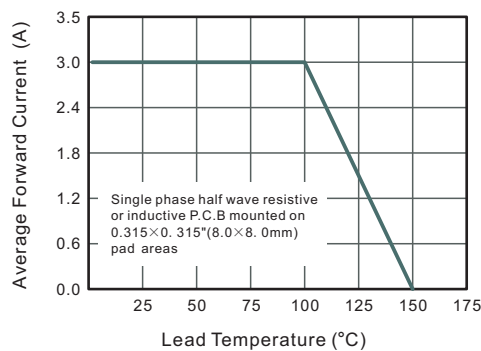


Fig.3 Typical Reverse Characteristics

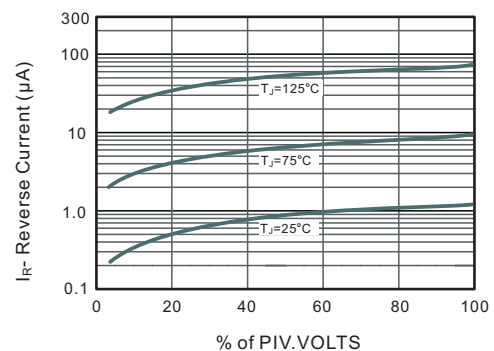


Fig.4 Typical Forward Characteristics

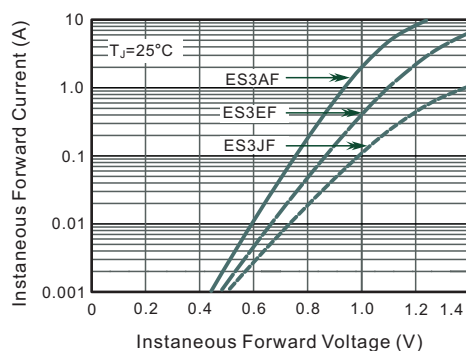
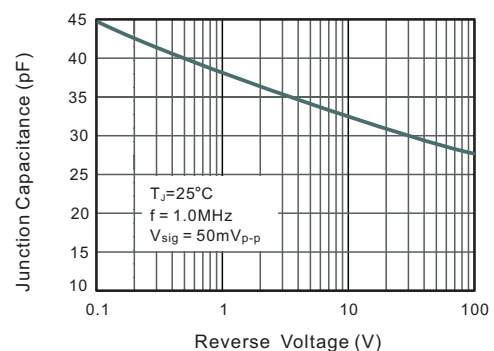


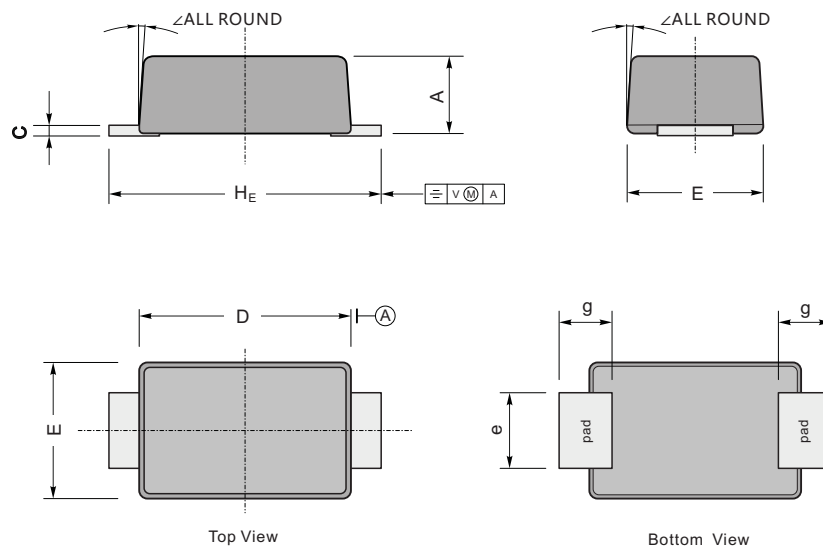
Fig.5 Typical Junction Capacitance



PACKAGE OUTLINE

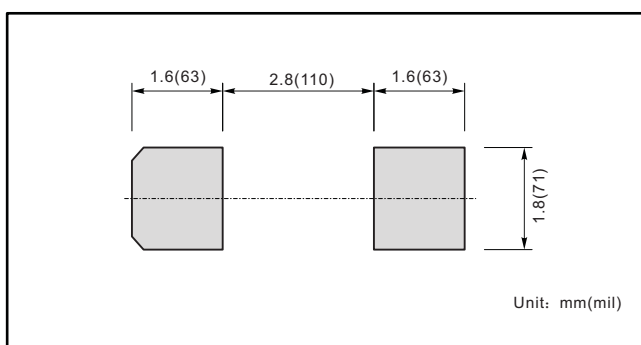
Plastic surface mounted package; 2 leads

SMAF



UNIT		A	C	D	E	e	g	H _E	$\angle$
mm	max	1.3	0.23	3.7	2.7	1.6	1.3	4.9	7°
	min	1.1	0.18	3.3	2.4	1.3	1.0	4.4	
mil	max	51	9.1	146	106	63	51	193	
	min	43	7.1	130	94	51	39	173	

The recommended mounting pad size



Marking

Type number	Marking code
ES3AF	ES3A
ES3BF	ES3B
ES3CF	ES3C
ES3DF	ES3D
ES3EF	ES3E
ES3GF	ES3G
ES3JF	ES3J